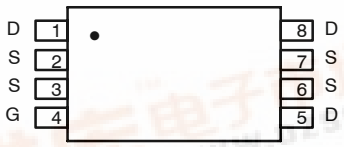
# N-Channel 2.5-V (G-S) MOSFET

| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{DS}$ (V) | $r_{DS(on)}$ (Ω) | $I_D$ (A) |
| 20 | 0.014 @ $V_{GS}$ = 4.5 V | 8.1 |
| | 0.020 @ $V_{GS}$ = 2.5 V | 6.6 |

## FEATURES

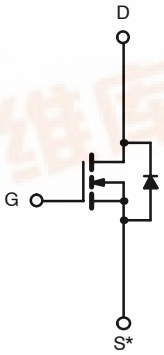
- TrenchFET® Power MOSFET
- 100% $R_g$ Tested

TSSOP-8




Top View

Ordering Information: Si6466ADQ-T1




N-Channel MOSFET

* Source Pins 2, 3, 6 and 7 must be tied common.

| ABSOLUTE MAXIMUM RATINGS ($T_A$ = 25°C UNLESS OTHERWISE NOTED) | | | | | |
|---|---|---|---|---|---|
| Parameter | | Symbol | 10 secs | Steady State | Unit |
| Drain-Source Voltage | | $V_{DS}$ | 20 | | V |
| Gate-Source Voltage | | $V_{GS}$ | ±8 | | |
| Continuous Drain Current ($T_J$ = 150°C)[a] | $T_A$ = 25°C | $I_D$ | 8.1 | 6.8 | A |
| | $T_A$ = 70°C | | 6.6 | 5.4 | |
| Pulsed Drain Current (10 µs Pulse Width) | | $I_{DM}$ | 30 | | |
| Continuous Source Current (Diode Conduction)[a] | | $I_S$ | 1.35 | 0.95 | |
| Maximum Power Dissipation[a] | $T_A$ = 25°C | $P_D$ | 1.5 | 1.05 | W |
| | $T_A$ = 70°C | | 1.0 | 0.67 | |
| Operating Junction and Storage Temperature Range | | $T_J$, $T_{stg}$ | -55 to 150 | | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|---|---|---|---|---|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient[a] | t ≤ 10 sec | $R_{thJA}$ | 65 | 83 | °C/W |
| | Steady State | | 100 | 120 | |
| Maximum Junction-to-Foot | Steady State | $R_{thJF}$ | 43 | 52 | |

Notes:
a. Surface Mounted on 1" x 1" FR4 Board.

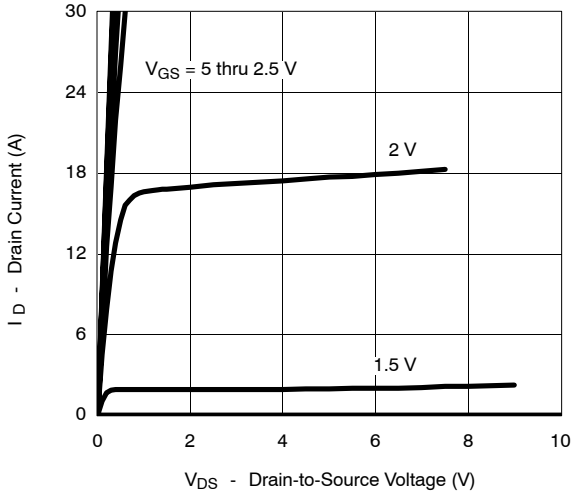
## SPECIFICATIONS ($T_J$ = 25°C UNLESS OTHERWISE NOTED)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **Static** | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 μA | 0.45 | | | V |
| Gate-Body Leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ±8 V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 16 V, $V_{GS}$ = 0 V | | | 1 | μA |
| | | $V_{DS}$ = 16 V, $V_{GS}$ = 0 V, $T_J$ = 70°C | | | 10 | |
| On-State Drain Current[a] | $I_{D(on)}$ | $V_{DS}$ = 5 V, $V_{GS}$ = 4.5 V | 20 | | | A |
| Drain-Source On-State Resistance[a] | $r_{DS(on)}$ | $V_{GS}$ = 4.5 V, $I_D$ = 8.1 A | | 0.011 | 0.014 | Ω |
| | | $V_{GS}$ = 2.5 V, $I_D$ = 6.6 A | | 0.017 | 0.020 | |
| Forward Transconductance[a] | $g_{fs}$ | $V_{DS}$ = 10 V, $I_D$ = 8.1 A | | 30 | | S |
| Diode Forward Voltage[a] | $V_{SD}$ | $I_S$ = 1.35 A, $V_{GS}$ = 0 V | | 0.65 | 1.1 | V |
| **Dynamic[b]** | | | | | | |
| Total Gate Charge | $Q_g$ | $V_{DS}$ = 10 V, $V_{GS}$ = 5 V, $I_D$ = 8.1 A | | 18 | 27 | nC |
| Gate-Source Charge | $Q_{gs}$ | | | 3.2 | | |
| Gate-Drain Charge | $Q_{gd}$ | | | 4 | | |
| Gate Resistance | $R_g$ | | 0.5 | | 1.8 | Ω |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}$ = 10 V, $R_L$ = 10 Ω<br>$I_D$ ≅ 1 A, $V_{GEN}$ = 4.5 V, $R_G$ = 6 Ω | | 27 | 45 | ns |
| Rise Time | $t_r$ | | | 34 | 50 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 76 | 120 | |
| Fall Time | $t_f$ | | | 30 | 50 | |
| Source-Drain Reverse Recovery Time | $t_{rr}$ | $I_F$ = 1.5 A, di/dt = 100 A/μs | | 35 | 70 | |

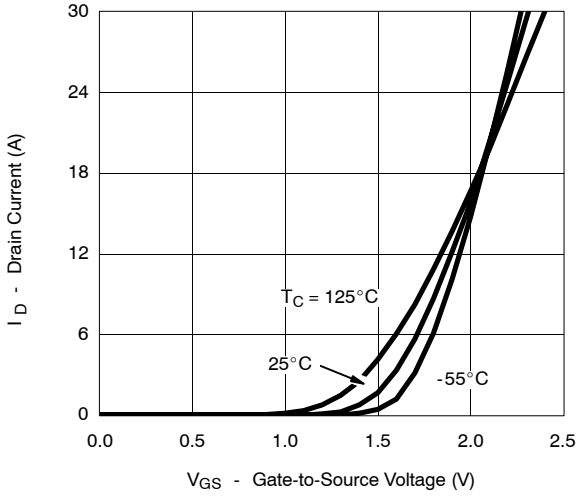
Notes
a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

**Output Characteristics**

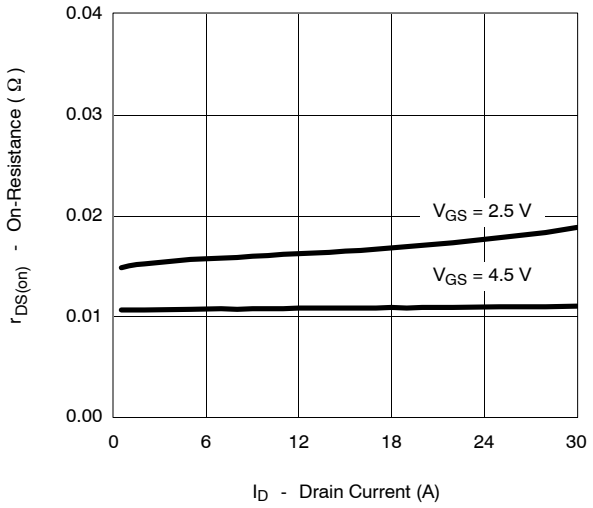



**Transfer Characteristics**

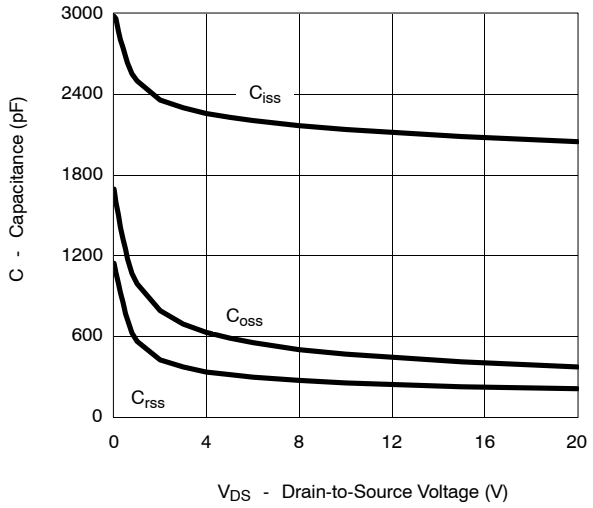


## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

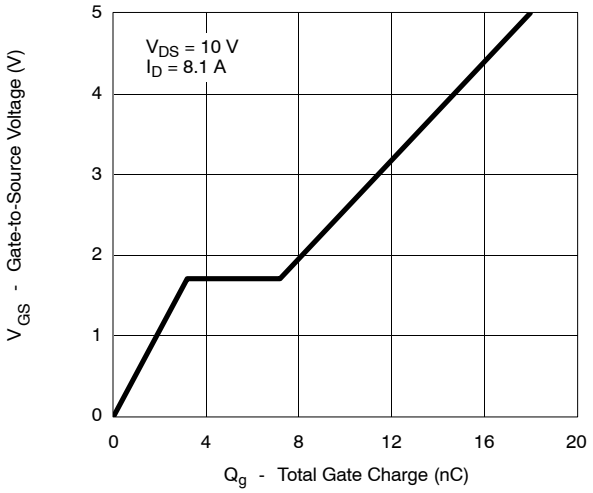
**On-Resistance vs. Drain Current**



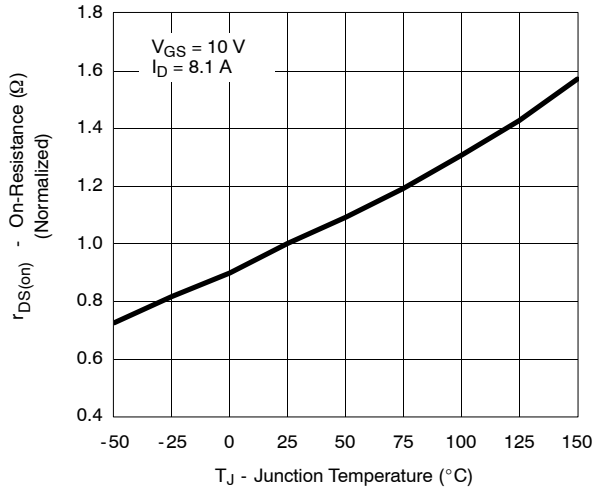

**Capacitance**



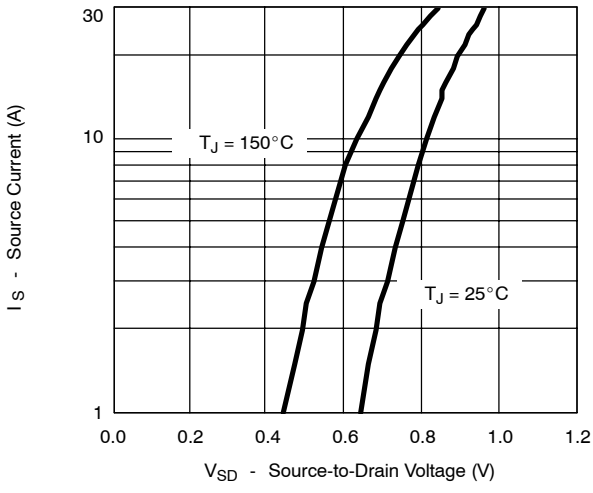

**Gate Charge**



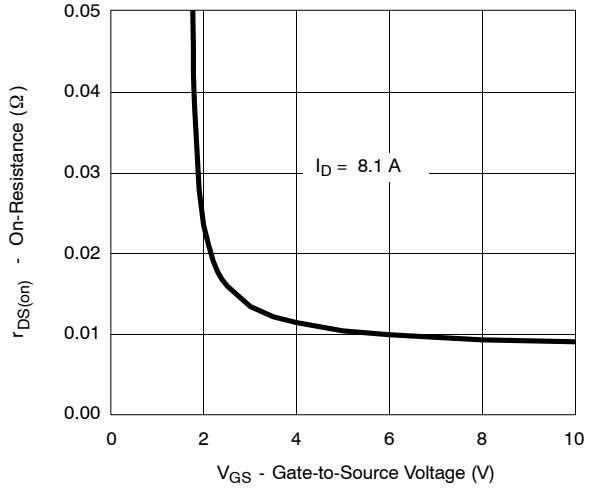

**On-Resistance vs. Junction Temperature**




**Source-Drain Diode Forward Voltage**

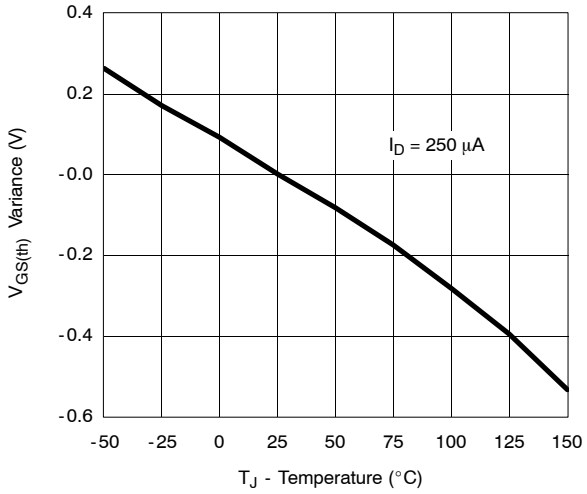



**On-Resistance vs. Gate-to-Source Voltage**

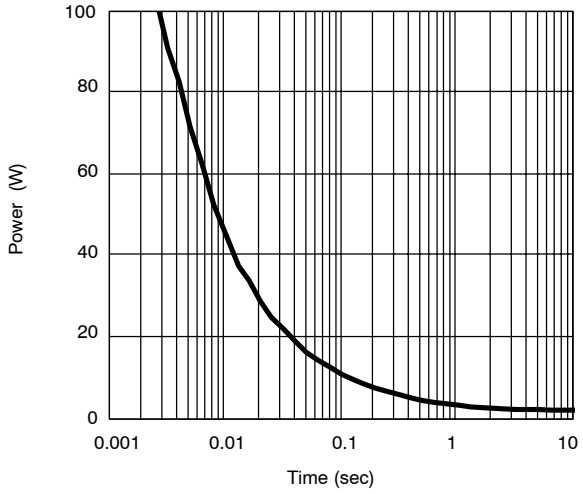


## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

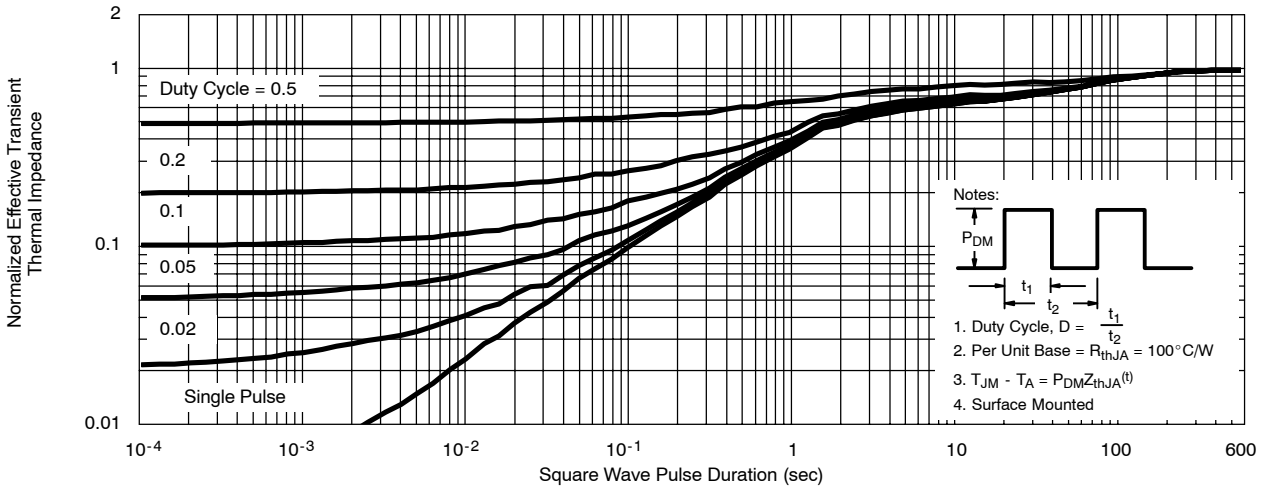
**Threshold Voltage**



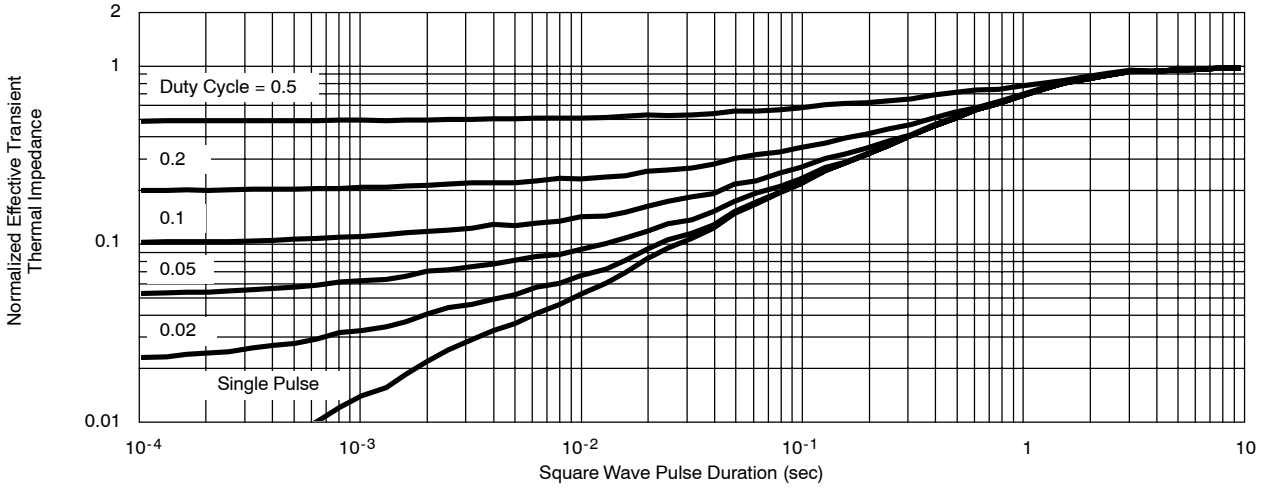

**Single Pulse Power, Junction-to-Ambient**




**Normalized Thermal Transient Impedance, Junction-to-Ambient**




**Normalized Thermal Transient Impedance, Junction-to-Foot**



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